

Description

The SJPL-F4 is a fast recovery diode of 400 V / 1.5 A. The maximum $t_{\rm rr}$ of 50 ns is realized by optimizing a life-time control.

Features

| • | V _{RM} | 400 | V |
|---|------------------|-----|----|
| • | $I_{F(AV)}$ | 1.5 | A |
| | V _F | | |
| • | t _{rr1} | 50 | ns |

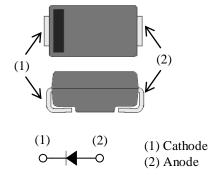
- Bare Lead Frame: Pb-free (RoHS Compliant)
- Suitable for High Reliability and Automotive Requirement.

Applications

- White Goods
- Audiovisual Equipment
- Lighting Equipment
- Industrial Electronic Equipment (Communication Equipment and Factory Automation)
- Secondary Side Rectifier Diode (Flyback Converter, LLC Converter, etc.)
- Freewheel Diode (Offline Buck and Buck-boost Converter)

Package

SJP



Not to scale

SJPL-F4

Absolute Maximum Ratings

Unless otherwise specified, $T_A = 25$ °C

| Parameter | Symbol | Rating | Unit | Conditions |
|---------------------------------|--------------------|------------|--------|--|
| Peak Repetitive Reverse Voltage | V _{RSM} | 400 | V | |
| Repetitive Reverse Voltage | V_{RM} | 400 | V | |
| Average Forward Current | I _{F(AV)} | 1.5 | A | See Figure 1 and Figure 2 |
| Surge Forward Current | I_{FSM} | 25 | A | Half cycle sine wave, positive side, 10 ms, 1 shot |
| I ² t Limiting Value | I^2t | 3.125 | A^2s | $1 \text{ ms} \le t \le 10 \text{ ms}$ |
| Junction Temperature | T _J | -40 to 150 | °C | |
| Storage Temperature | T_{STG} | -40 to 150 | °C | |

Electrical Characteristics

Unless otherwise specified, $T_A = 25$ °C

| Parameter | Symbol | Conditions | Min. | Тур. | Max. | Unit |
|---|----------------------|---|------|------|------|------|
| Formand Waltons Drop | V_{F} | $T_J = 25 ^{\circ}\text{C}, I_F = 1.5 \text{A}$ | _ | _ | 1.3 | V |
| Forward Voltage Drop | | $T_J = 100 ^{\circ}\text{C}, I_F = 1.5 \text{A}$ | _ | 1.0 | _ | V |
| Reverse Leakage Current | I_R | $V_R = V_{RM}$ | _ | _ | 10 | μΑ |
| Reverse Leakage Current Under High Temperature | $H \cdot I_R$ | $V_R = V_{RM}$, $T_J = 150$ °C | | _ | 50 | μΑ |
| | t_{rr1} | $I_F = I_{RP} = 100 \text{ mA}$ 90% recovery point, $T_J = 25 ^{\circ}\text{C}$ | _ | | 50 | ns |
| Reverse Recovery Time | t _{rr2} | $I_F = 100 \text{ mA},$ $I_{RP} = 200 \text{ mA},$ $75\% \text{ recovery point},$ $T_J = 25 \text{ °C}$ | _ | | 35 | ns |
| Thermal Resistance (1) | R _{th(J-L)} | | _ | _ | 20 | °C/W |

 $^{^{(1)}\,}R_{\text{th (J-L)}}$ is thermal resistance between junction and lead.

Rating and Characteristic Curves

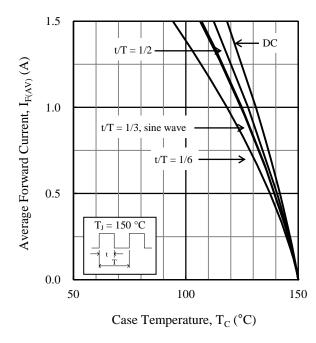


Figure 1. $T_C \text{ vs. } I_{F(AV)} \text{ Typical Characteristics } (V_R = 0 \text{ V})$

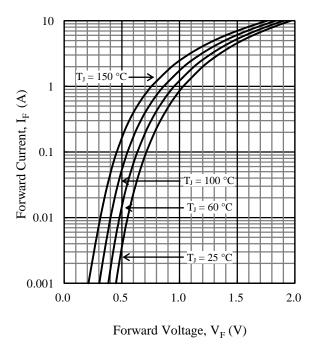


Figure 3. V_F vs. I_F Typical Characteristics

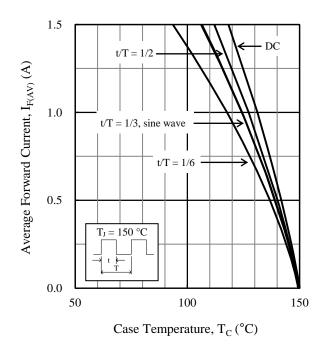


Figure 2. T_C vs. $I_{F(AV)}$ Typical Characteristics $(V_R = 400 \text{ V})$

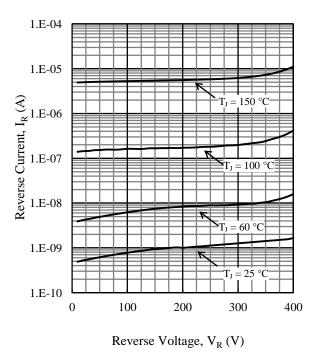
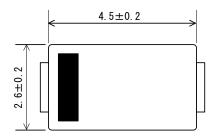
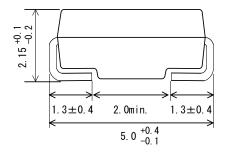


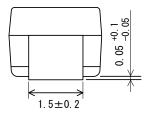
Figure 4. V_R vs. I_R Typical Characteristics

Physical Dimensions

• SJP Package







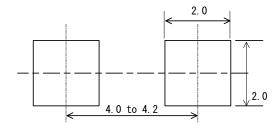
NOTES:

- Dimensions in millimeters
- Bare lead frame: Pb-free (RoHS compliant)
- When soldering the products, be sure to minimize the working time, within the following limits: Flow: 260 ± 5 °C / 10 ± 1 s, 2 times

Soldering Iron: 380 ± 10 °C / 3.5 ± 0.5 s, 1 time

- MSL: JEDEC LEVEL1

• SJP Land Pattern Example



NOTE:

- Dimensions in millimeters

Marking Diagram

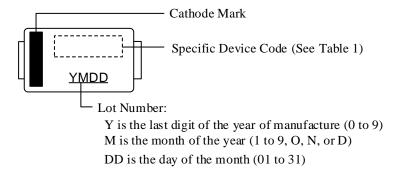


Table 1. Specific Device Code

| Specific Device Code | Part Number |
|----------------------|-------------|
| LF4 | SJPL-F4 |

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